

QSP-100B123-20CL

100Gbps QSFP28 BIDI Single Lambda Transceiver, Single Mode, 20km Reach

Features

- Supports 100GBASE-LR1-20 BIDI
- Lane signaling rate 106.25Gb/s with PAM4
- Up to 20km transmission on SMF
- EML Laser and PIN receiver
- 4x25.78Gb/s with NRZ electrical interface (CAUI-4)
- High speed I/O electrical interface
- I2C interface with integrated Digital Diagnostic monitoring
- QSFP28 MSA package with simplex LC connector
- Single +3.3V power supply
- Support HW TX_DIS and RX_LOS for telecom application
- Maximum power consumption 4.5 W
- Operating case temperature: 0 to +70 °C
- Compliant to 802.3cu, SFF-8636&SFF-8679 standard
- Complies with EU Directive 2015/863/EU



Applications

- 100GBASE-LR1-20 BIDI

Absolute Maximum Ratings

Table 1- Absolute Maximum Ratings

Parameter	Symbol	Min	Typical	Max	Units	Notes
Storage Temperature	T _s	-40		+85	°C	
Supply Voltage	VCC	-0.5	-	+4.0	V	
Operating Relative Humidity	RH	-	-	+85	%	

Recommended Operating Environment

Table 2 - Recommended Operating Environment

Parameter	Symbol	Min	Typical	Max	Units	Notes
Operating Case Temperature	Tc	0	-	+70	°C	
Power Supply Voltage	VCC	3.13	3.3	3.47	V	
Power Supply Current	ICC	-	-	1.3	A	
Maximum Power Dissipation	PD	-	-	4.5	W	
Data Rate(optical)	DRo	-	106.25	-	Gb/s	
Transmission Distance	TD	-	-	20	km	Over SMF

Optical Characteristics

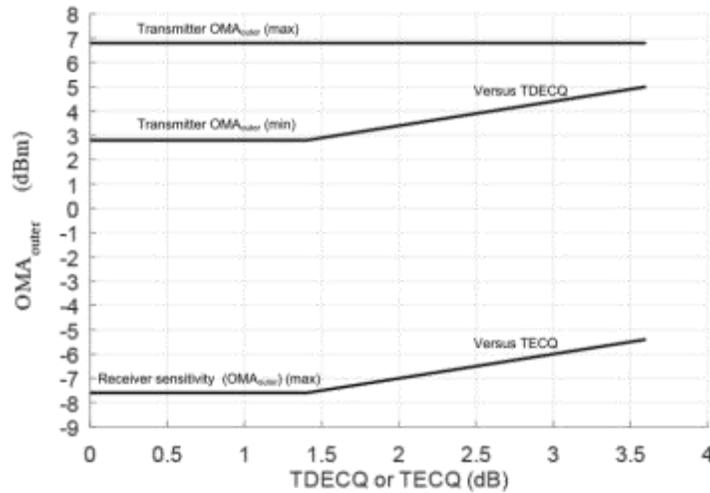
Table 3- Optical Characteristics

Transmitter						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Center Wavelength	CW	1284.5	1291	1297.5	nm	
Average Launch Power	PTX	-0.2	-	6.6	dBm	1
Outer Optical Modulation Amplitude	OMA	2.8	-	6.8	dBm	TDECQ<1.4
		1.4+TDECQ	-		dBm	1.4≤TDECQ
Transmitter and dispersion eye closure for PAM4 (TDECQ) (max)	TDECQ	-	-	3.6	dBm	
Transmitter eye closure for PAM4 (TECQ) (max)	TECQ	-	-	3.4	dBm	
TDECQ-TECQ (max)	-	-	-	2.7	dB	
Average Output Power (Laser Turn off)	P0UT-OFF	-	-	-15	dBm	
Side Mode Suppression Ratio	SMSR	30	-	-	dB	
Extinction Ratio	ER	3.5	-	-	dB	
Receiver						
Center Wavelength	CW	1304.5	1311	1317.5	nm	
Damage threshold	Pdamage	7.6	-	-	dBm	2
Average Rx Power	PRX	-10	-	6.6	dBm	3
Receive power_OMAAouter	POMA	-	-	6.8	dBm	
Receiver sensitivity_OMAAouter	SEN_OMA	-	-	-7.6	dBm	TECQ≤1.4
		-	-	-9+TECQ	dBm	1.4≤TECQ≤3.6
Los Assert	LosA	-26	-	-	dBm	

Los De-Assert	LosDA	-	-	-11	dBm	
Los Hysteresis	LosH	0.5	-	-	dB	

Notes:

1. The optical power is launched into SMF. The transmitter wavelength range supports a broad range of transmitter types which may have different chirp characteristics. Compliance to the TDECQ and TECQ specifications may require a tighter wavelength range depending on the chirp characteristics of the transmitter
2. The receiver shall be able to tolerate, without damage, continuous exposure to an optical input signal having this average power level. The receiver does not have to operate correctly at this input power.
3. Average receive power, each lane (min) is informative and not the principal indicator of signal strength.



Electrical Characteristics

Table 4- Electrical Characteristics

Transmitter (Module Input)						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Input Differential Impedance	R _{in}	-	100	-	Ohm	
Differential Data Input Amplitude	V _{IN,P-P}	80	-	900	mVpp	
Differential termination mismatch (max)	D-mismatch	-	-	10	%	
DC common-mode input voltage		-0.3	-	2.8	V	
Transition time(20%~80%)	Tr Tf	10	-	-	ps	
LPMODE, Reset and ModSelL / Tx dis	V _{IL}	-0.3	-	0.8	V	
LPMODE, Reset and ModSelL / Tx dis	V _{IH}	2.0	-	V _{CC} +0.3	V	
Receiver (Module Output)						
Output Differential Impedance	R _{out}	-	100	-	Ohm	
Differential Data Output Amplitude	V _{OUT,P-P}	-	-	900	mVpp	

Differential termination mismatch (max)	D-mismatch	-	-	10	%	
Transition time, 20% to 80%	Tr Tf	12	-		ps	
ModPrsL and IntL/ Rx los	VoL	0	-	0.4	V	
ModPrsL and IntL/ Rx los	VoH	Vcc-0.5	-	Vcc+0.3	V	

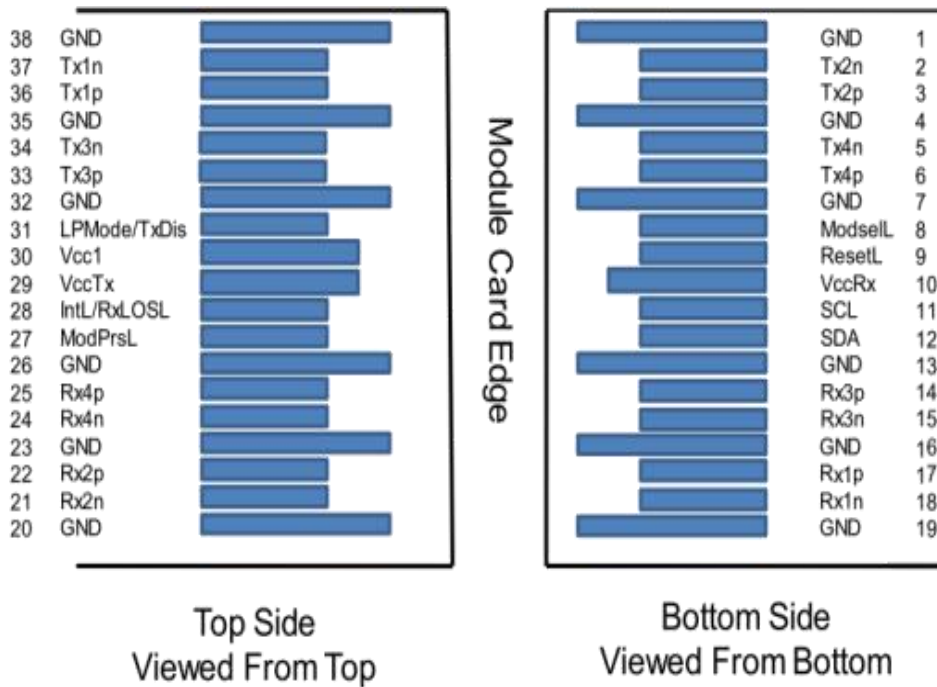
Digital Diagnostics

Table 5- Digital Diagnostics

Parameter	Range	Accuracy	Unit	Calibration
Temperature	0 to 70	±3	°C	Internal
Voltage	0 to VCC	10%	V	Internal
Tx Bias Current	0 to 100	10%	mA	Internal
Tx Output Power	-0.2 to 6.6	±3	dBm	Internal
Rx Power	-10 to 6.6	±3	dBm	Internal

Pin Assignment

Pin Diagram



Pin Descriptions

Table 6- Pin Descriptions

PIN	Logic	Symbol	Description	Plug Seq.	Notes
1		GND	Ground	1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Tx2p	Transmitter Non-Inverted Data output	3	
4		GND	Ground	1	1
5		NC		3	
6		NC		3	
7		GND	Ground	1	1
8	LVTTLL-I	ModSelL	Module Select	3	
9	LVTTLL-I	ResetL	Module Reset	3	
10		VccRx	+3.3V Power Supply Receiver	2	2
11	LVCNOS-I/O	SCL	2-Wire Serial Interface Clock	3	
12	LVCNOS-I/O	SDA	2-Wire Serial Interface Data	3	
13		GND	Ground	1	
14		NC		3	
15		NC		3	
16		GND	Ground	1	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3	
18	CML-O	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1
20		GND	Ground	1	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24		NC		3	
25		NC		3	
26		GND	Ground	1	1
27	LVTTTL-O	ModPrsL	Module Present	3	
28	LVTTTL-O	IntL	Interrupt	3	
29		VccTx	+3.3 V Power Supply transmitter	2	2
30		Vcc1	+3.3 V Power Supply	2	2

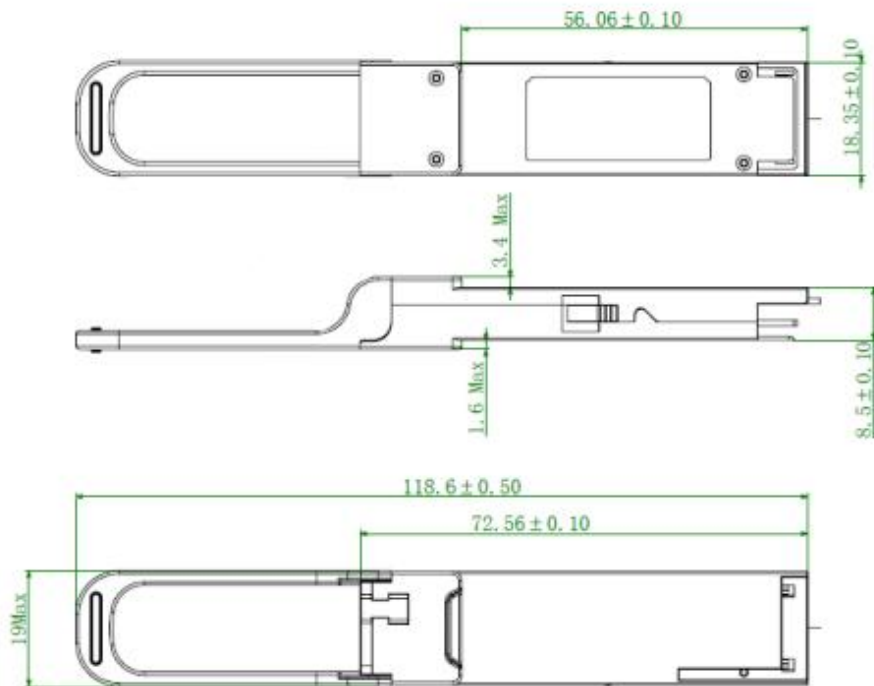
31	LVTTTL-I	LPMODE	Low Power Mode	3	
32		GND	Ground	1	1
33		NC		3	
34		NC		3	
35		GND	Ground	1	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3	
37	CML-I	Tx1n	Transmitter Inverted Data Output	3	
38		GND	Ground	1	1

Note :

1.GND is the symbol for signal and supply (power) common for the QSFP28 module. All are common within the QSFP28 module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

2.Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in MSA. The connector pins are each rated for a maximum current of 1000 mA.

Mechanical Dimension



Order Information

Table 7- Ordering information

Part Number	Product Description
QSP-100B123-20CL	100G QSFP28 BIDI Transceiver, TX1291nm/RX1311nm, Simplex LC, 20km, 0~+70°C, with DDM

AscentOptics reserves the right to make changes to the product(s) or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information. Published by Ascent Optics Co.,Ltd. Copyright © Ascent Optics All Rights Reserved.

E-mail: sales@ascentoptics.com

Web : <http://www.ascentoptics.com>